



SamHop Microelectronics Corp.

**STM6914**

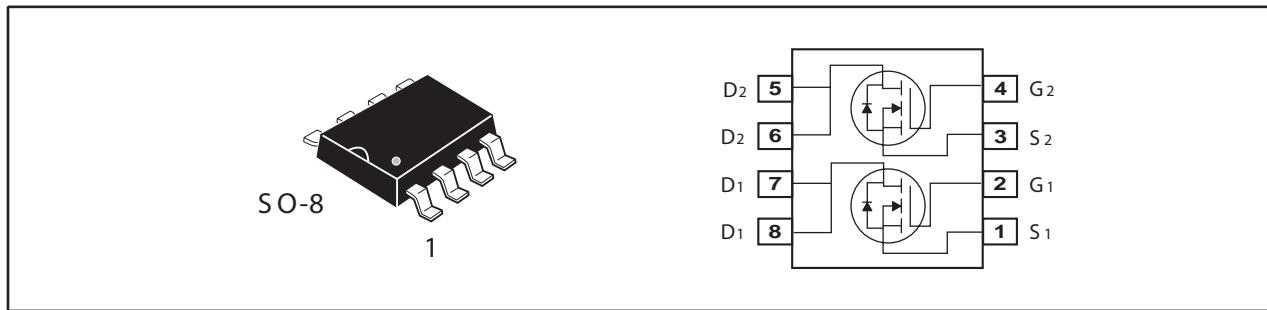
Ver 1.1

## Dual N-Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
VDSS	ID	RDS(ON) (mΩ) Max
30V	6.5A	32 @ VGS=10V
		52 @ VGS=4.5V

### FEATURES

- Super high dense cell design for low Rds(ON).
- Rugged and reliable.
- Surface Mount Package.



### ABSOLUTE MAXIMUM RATINGS ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter		Limit	Units
$V_{DS}$	Drain-Source Voltage		30	V
$V_{GS}$	Gate-Source Voltage		$\pm 20$	V
$I_D$	Drain Current-Continuous <sup>a</sup>	$T_A=25^\circ\text{C}$	6.5	A
		$T_A=70^\circ\text{C}$	5.2	A
$I_{DM}$	-Pulsed <sup>b</sup>		24	A
$P_D$	Maximum Power Dissipation <sup>a</sup>	$T_A=25^\circ\text{C}$	2	W
		$T_A=70^\circ\text{C}$	1.28	W
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range		-55 to 150	$^\circ\text{C}$

### THERMAL CHARACTERISTICS

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient <sup>a</sup>	62.5	$^\circ\text{C/W}$
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## ELECTRICAL CHARACTERISTICS ( $T_A=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>OFF CHARACTERISTICS</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	30			V
$I_{DS}^S$	Zero Gate Voltage Drain Current	$V_{DS}=24V, V_{GS}=0V$		1		$\mu A$
$I_{GSS}$	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			$\pm 100$	$nA$
<b>ON CHARACTERISTICS</b>						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1	1.9	3	V
$R_{DS(ON)}$	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=6.5A$		26	32	m ohm
		$V_{GS}=4.5V, I_D=5.1A$		40	52	m ohm
$g_{FS}$	Forward Transconductance	$V_{DS}=5V, I_D=6.5A$		7		S
<b>DYNAMIC CHARACTERISTICS <sup>c</sup></b>						
$C_{ISS}$	Input Capacitance	$V_{DS}=15V, V_{GS}=0V$ $f=1.0MHz$		513		pF
$C_{OSS}$	Output Capacitance			91		pF
$C_{RSS}$	Reverse Transfer Capacitance			73		pF
<b>SWITCHING CHARACTERISTICS <sup>c</sup></b>						
$t_{D(ON)}$	Turn-On Delay Time	$V_{DD}=15V$ $I_D=1A$ $V_{GS}=10V$ $R_{GEN}=6\text{ ohm}$		10		ns
$t_r$	Rise Time			11		ns
$t_{D(OFF)}$	Turn-Off Delay Time			17.5		ns
$t_f$	Fall Time			10.5		ns
$Q_g$	Total Gate Charge	$V_{DS}=15V, I_D=6.5A, V_{GS}=10V$		9.2		nC
		$V_{DS}=15V, I_D=6.5A, V_{GS}=4.5V$		4.7		nC
$Q_{gs}$	Gate-Source Charge	$V_{DS}=15V, I_D=6.5A,$ $V_{GS}=4.5V$		1.3		nC
$Q_{gd}$	Gate-Drain Charge			2.7		nC
<b>DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS</b>						
$I_s$	Maximum Continuous Drain-Source Diode Forward Current			2		A
$V_{SD}$	Diode Forward Voltage <sup>b</sup>	$V_{GS}=0V, I_s=2A$		0.82	1.2	V
<b>Notes</b>						
a.Surface Mounted on FR4 Board,t < 10sec.						
b.Pulse Test:Pulse Width < 300us, Duty Cycle < 2%.						
c.Guaranteed by design, not subject to production testing.						

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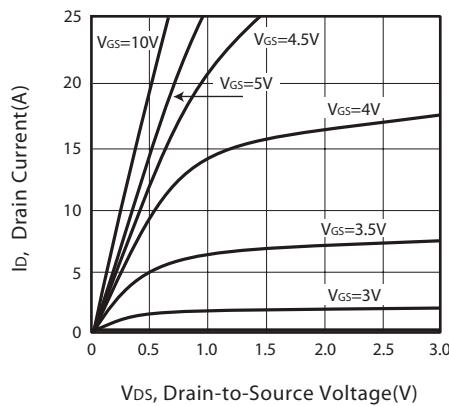


Figure 1. Output Characteristics

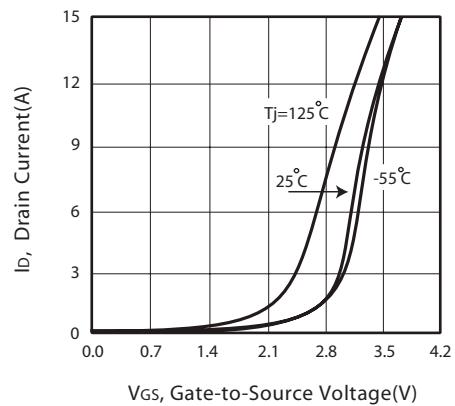


Figure 2. Transfer Characteristics

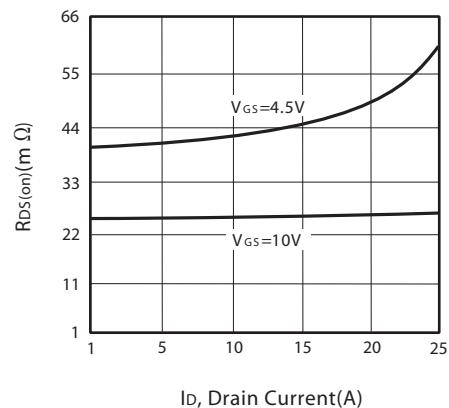


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

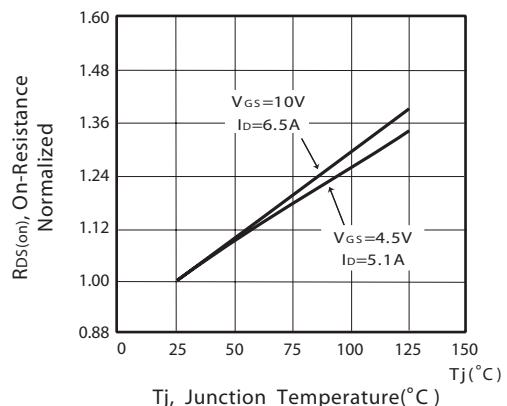


Figure 4. On-Resistance Variation with Drain Current and Temperature

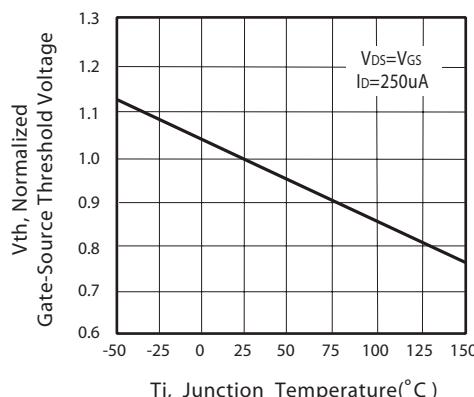


Figure 5. Gate Threshold Variation with Temperature

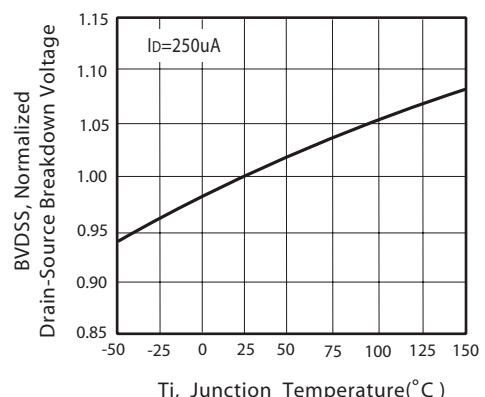
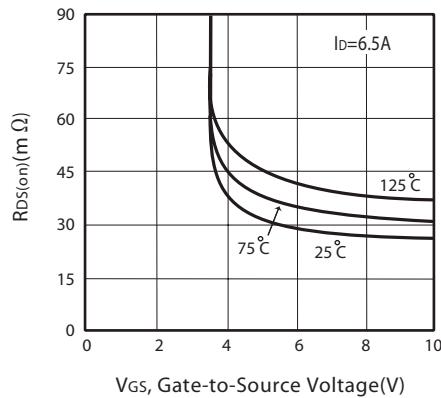


Figure 6. Breakdown Voltage Variation with Temperature

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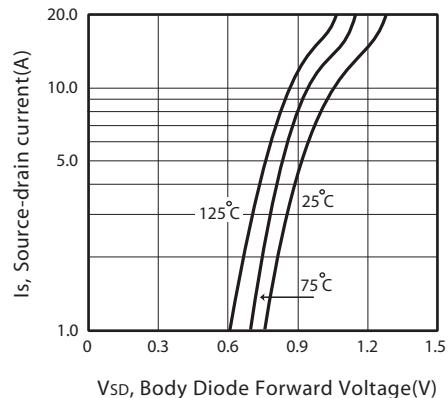
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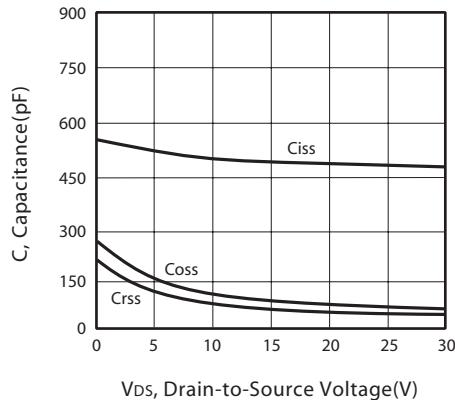
V<sub>GS</sub>, Gate-to-Source Voltage(V)

Figure 7. On-Resistance vs. Gate-Source Voltage



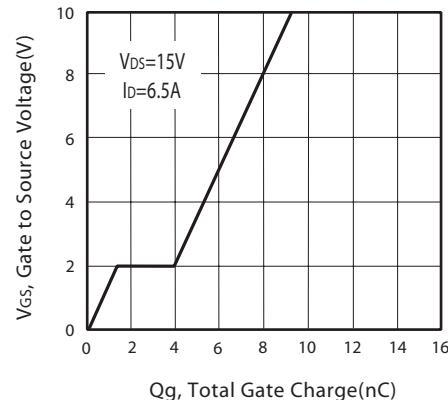
V<sub>SD</sub>, Body Diode Forward Voltage(V)

Figure 8. Body Diode Forward Voltage Variation with Source Current



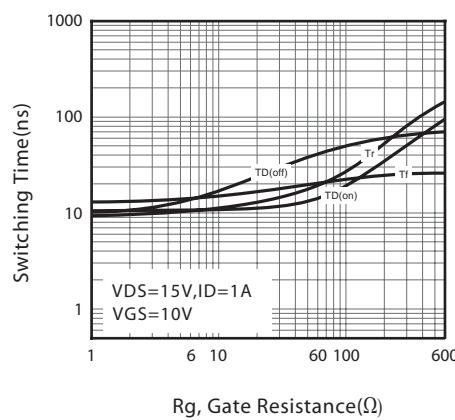
V<sub>DS</sub>, Drain-to-Source Voltage(V)

Figure 9. Capacitance



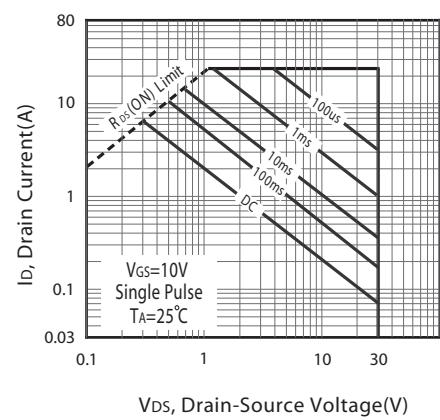
Q<sub>g</sub>, Total Gate Charge(nC)

Figure 10. Gate Charge



R<sub>g</sub>, Gate Resistance(Ω)

Figure 11. switching characteristics

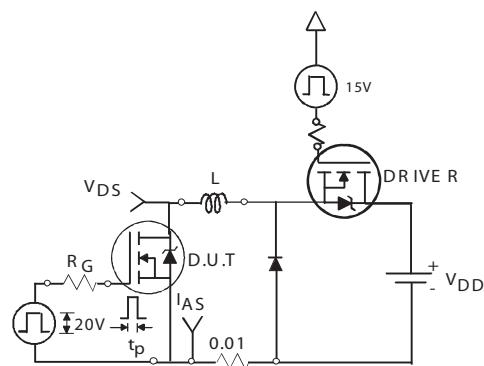


V<sub>DS</sub>, Drain-Source Voltage(V)

Figure 12. Maximum Safe Operating Area

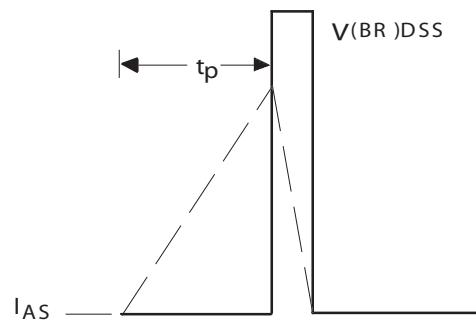
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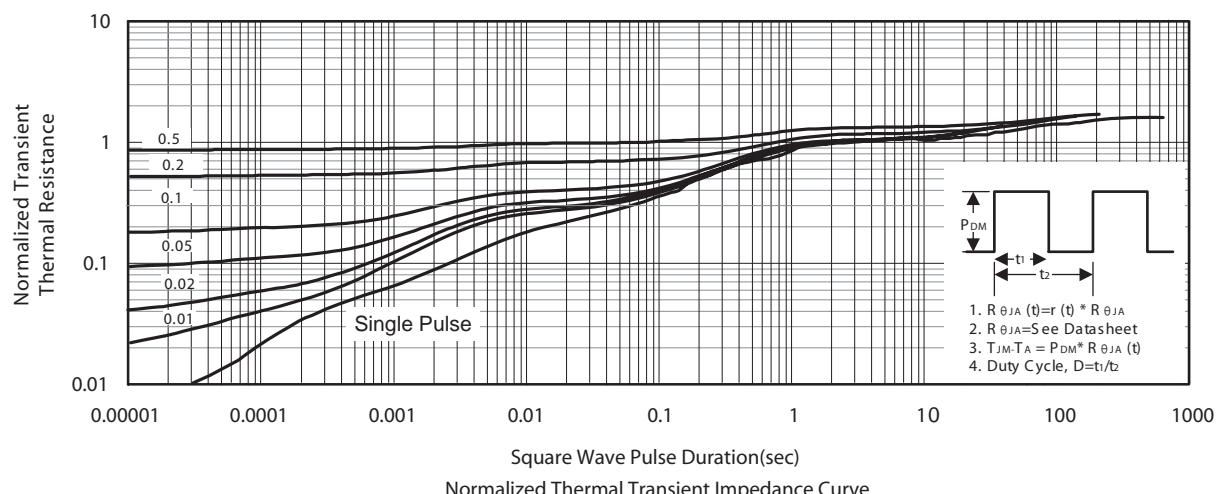
Unclamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.



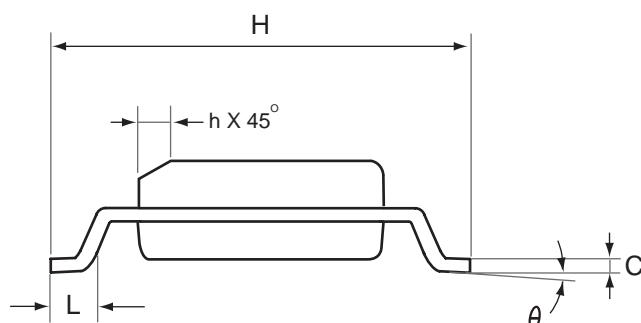
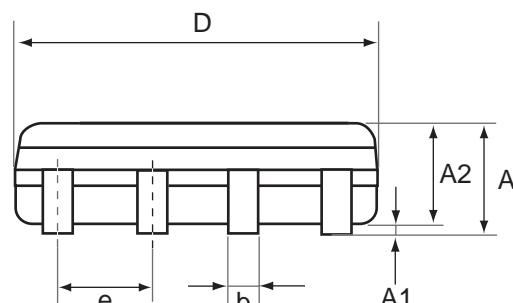
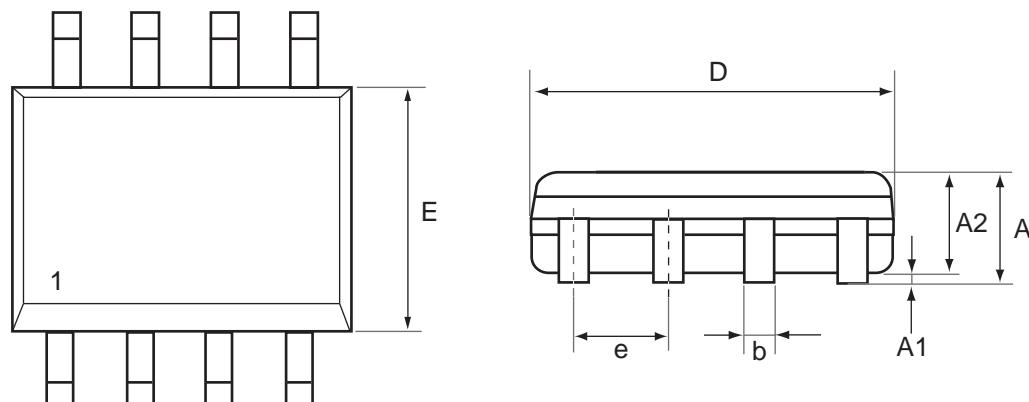
Square Wave Pulse Duration(sec)

Normalized Thermal Transient Impedance Curve

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## PACKAGE OUTLINE DIMENSIONS

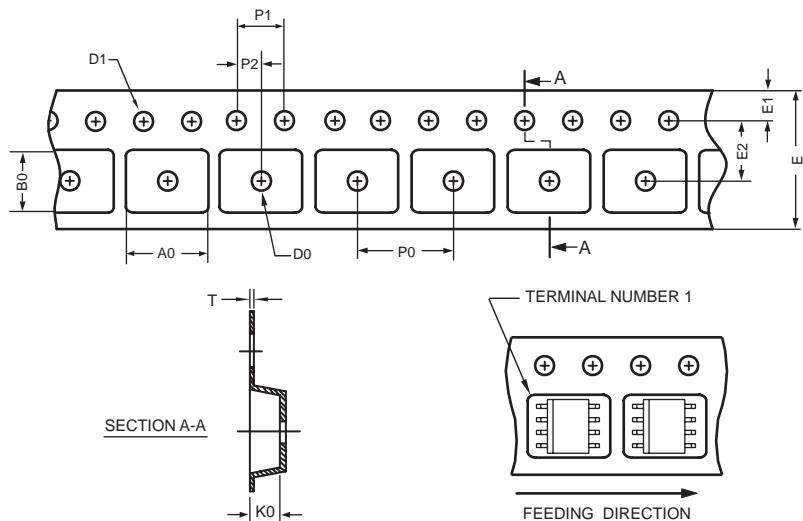
**SO-8**



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.35	1.75	0.053	0.069
A1	0.10	0.25	0.004	0.010
A2	1.25	1.63	0.049	0.064
b	0.31	0.51	0.012	0.020
C	0.17	0.25	0.007	0.010
D	4.80	5.00	0.189	0.197
E	3.70	4.00	0.146	0.157
e	1.27 REF.		0.050 BSC	
H	5.80	6.20	0.228	0.244
L	0.40	1.27	0.016	0.050
$\theta$	$0^\circ$	$8^\circ$	$0^\circ$	$8^\circ$
h	0.25	0.50	0.010	0.020

## SO-8 Tape and Reel Data

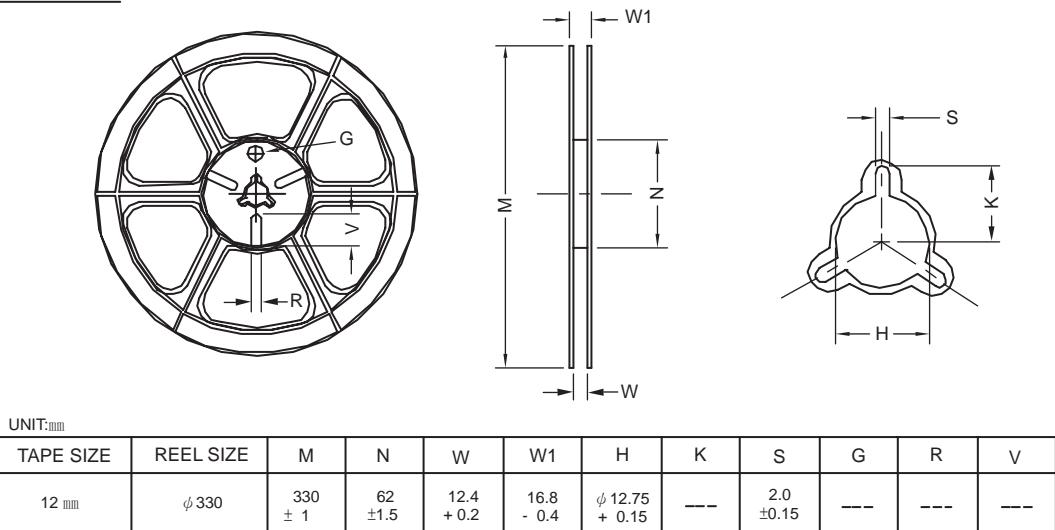
### SO-8 Carrier Tape



unit:mm

PACKAGE	A0	B0	K0	D0	D1	E	E1	E2	P0	P1	P2	T
SOP 8N 150mil	6.50 ±0.15	5.25 ±0.10	2.10 ±0.10	ψ 1.5 (MIN)	ψ 1.55 ±0.10	12.0 +0.3 -0.1	1.75 ±0.10	5.5 ±0.10	8.0 ±0.10	4.0 ±0.10	2.0 ±0.10	0.30 ±0.013

### SO-8 Reel



## TOP MARKING DEFINITION

SO-8

